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The construction of production performance prediction system for semiconductor manufacturing with artificial neural networks
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The construction of production performance prediction system for semiconductor manufacturing with artificial neural networks


The major performance measurements for wafer fabrication system comprise WIP level, throughput and cycle time. These measurements are influenced by various factors, including machine breakdown, operator absence, poor dispatching rules, emergency order and material shortage. Generally, production managers use the WIP level profile of each stage to identify an abnormal situation, and then make corrective actions. However, such a measurement is reactive, not proactive. Proactive actions must effectively predict the future performance, analyze the abnormal situation, and then generate corrective actions to prevent performance from degrading. This work systematically constructs artificial neural network models to predict production performances for a semiconductor manufacturing factory. An application for a local DRAM wafer fabrication has demonstrated the accuracy of neural network models in predicting production performances.

1. Introduction

Three major performance measurements in a wafer fabrication consist of the WIP level, throughput (move volume) and cycle time. The relationships among these performance measurements and the disturbance factors (e.g. machine breakdown, material shortage and emergency order) are quite complicated. For instance, machine breakdown may increase the WIP level, prolong the cycle time, and thereby influence the throughput of the downstream stages even further. A circumstance in which disturbance events occur daily poses difficulty for the production manager to maintain system performance. Therefore, the undesirable effects must be known in advance so that the proper corrective actions can be taken to prevent degrading performance. In practice, production managers use the WIP level profile of each operation stage to identify an abnormal situation and make necessary correcting actions. Such a measurement is reactive, not proactive. A proactive way must predict the future performance, identify and analyze an abnormal situation, and then generate necessary corrective actions to prevent abnormal performance decreasing.

Several models, including simulation, queueing, spreadsheet, regression and neural networks, can be employed to predict production performance. Of these,
simulation, regression and neural networks are the most widely used. In order to build a simulation model to predict and control the performance of a system subject to disturbances, the characteristics of these disturbances must first be estimated and used as input variables. Then by introducing changes in these characteristics their effect on the system performances (output variable) can be methodically evaluated. However, considering all the system disturbances in one simulation model is extremely difficult. Moreover, detailed simulations require an enormous amount of time and money to write and maintain, especially in the semiconductor manufacturing environment; in addition, several hours are necessary to run them even on a powerful computer (Connors et al. 1996). Besides this, the accuracy in predicting wafer fabrication performance with simulation model still remains questionable due to its dynamic nature and complexity.

Multiple regression is a general statistical technique used to analyze the relationship between a single dependent (predicted) variable and several independent ones (predictors). Multiple linear regression produces a linear approximation to fit the data. Variable transformation allows, to some extent, the linear regression methods to handle nonlinear cases. However, such a transformation may make it difficult to interpret the results. We could always find a polynomial of a higher degree that would yield a perfect fit to a specified data set. Thus, this results in overfitting and an inability of the regression model to generalize (Shyur et al. 1996).

Neural networks are becoming more and more well known, and have been successfully implemented in manufacturing (Udo 1992, Zhang and Huang 1995). For instance, Philipoom et al. (1994) using neural network models, forecast the order due-date in a flow shop manufacturing system. The neural network model yielded better forecasting results than conventional due-date assignment approaches (Philipoom et al. 1994).

Using historical data as the input variables, the regression model and neural network model can represent the properties and variations of a system. When a system is stable, acceptable forecasting accuracy using the two models is expected. However, finding a nonlinear regression model that can correspond to the historical data and represent the system’s status is difficult. Many independent variables must be considered in our case. Furthermore, some of the data do not fit the basic assumptions of regression models. Thus, additional data transformations are necessary to generate our regression model. Alternatively, creating neural network models does not have the above conditions. Moreover, in practice, neural network models can yield better results than regression models (Philipoom et al. 1994, Shyur et al. 1996). Using the neural network models to predict wafer fabrication’s production performance has the following merits.

(1) Neural networks can obtain a probable result even if the input data are incomplete or noisy.
(2) A well-trained neural network model can provide a real time forecasting result.
(3) Creating a neural network model does not necessitate understanding the complex relationship among input variables.

Back-propagation neural networks (BPN) are widely used, and they produce good results in prediction and pattern recognition. Therefore, this work attempts to construct BPN prediction models. According to the field managers’ experiences, WIP level and wafer move in previous time periods and upstream operation stages are
selected as the input variables in our BPN model. A systematic construction procedure is presented in the third section.

2. Neural network models

Neural networks are computing systems that incorporate a simplified model of the human neuron, organized into networks similar to those found in the human brain. Artificial neural networks are computer simulations of biological neurons. Neural networks are composed of processing elements (nodes) and connections. Each processing element has an output signal that fans out along the connections to the other processing elements. Each connection is assigned a relative weight. A node’s output depends on the threshold specified and the transfer function. The two types of learning are supervised and unsupervised. For supervised learning, a set of training input vectors with a corresponding set of target vectors is trained to adjust the weights in a neural network. For unsupervised learning, a set of input vectors is proposed; however, no target vectors are specified. Our approach towards the performance prediction problem is based on supervised neural networks. Supervised learning neural network models include back-propagation, counter-propagation network and learning vector quantization, of which, the back-propagation model is most extensively used and is therefore selected here.

A back-propagation neural network (BPN) can be layered into many levels, with or without hidden layers exhibited between an input and an output layer. Figure 1 illustrates a network of neurons that are organized into a three layer hierarchy. Back-propagation learning employs a gradient-descent algorithm (Rumelhart and McClelland 1989). Through a supervised learning rule, the collected training data set comprises an input and an actual target output. The gradient-descent learning algorithm enables a network to enhance the performance by self-learning. Two phases are available for computation: forward and backward. In the forward phase of back-propagation learning, the input data pattern is directly passed into the hidden layer. Each element of the hidden layer calculates an activation value by summing up the

![Figure 1. An example of three-layer backpropagation neural network.](image-url)
weighted inputs and then transforms the weighted input into an activity level by using a transfer function (the sigmoid function is broadly used). The resulting activity is allowed to spread through the network to the output layer. If a difference arises, i.e., an error term, the gradient-descent algorithm is used to adjust the connected weights, in the backward phase. This learning process is repeated until the error between the actual and desired output (target) converges to a predefined threshold. A trained neural network is expected to predict the output when a new input pattern is provided to it.

In the backward phase, the network output $y_k$ is compared with the target value $t_k$ to determine the associated error for that pattern with that unit. Based on this error, the factor $\delta_k$ is computed. $\delta_k$ is used to distribute the error at output unit $Y_k$ back to all units in the previous layer (the hidden units that are connected to $Y_k$). It is also used to update the weights between the output and the hidden layer. In a similar manner, the factor $\delta_j$ is computed for each hidden unit $Z_j$. $\delta_j$ is used to update the weights between the hidden layer and the input layer.

After all the $\delta$ factors have been determined, the weights for all layers are adjusted simultaneously. The adjustment to the weight $W_{jk}$ (from hidden unit $Z_j$ to output unit $Y_k$) is based on the factor $\delta_k$, the activation $z_j$ of the hidden unit $Z_j$, and the learning rate $\eta$. The adjustment to the weights $v_{ij}$ (from input unit $X_i$ to hidden unit $Z_j$) is based on the factor $\delta_j$, the activation $x_i$ of the input unit, and the learning rate $\eta$. The equation utilized to adjust the weights for the output layer $k$ is

$$\Delta w_{jk} = \eta_k z_j,$$

where

$\Delta W_{jk}$ is the change to be made in the weight from the $j$th to $k$th unit,
$\eta$ is the learning rate,
$\delta_k$ is the error signal for unit $k$,
$z_j$ is the $j$th element of the output pattern.

The back-propagation rule for changing weights for the hidden layer $j$ is

$$\Delta v_{ij} = \eta_j x_i,$$

where

$\Delta v_{ij}$ is the change to be made in the weight from the $i$th to $j$th unit,
$\eta$ is the learning rate,
$\delta_j$ is the error signal for unit $j$,
$x_i$ is the $i$th element of the input pattern.

3. BPN prediction model construction

As figure 2 shows, constructing a BPN prediction model involves three steps: (a) performing correlation analysis to obtain proper input variables, (b) applying experimental design method to determine a good level combination of input variables, and (c) applying an experimental design method to determine the optimum BPN structure.

3.1. Input factors selection

Creating a BPN model initially involves determining the input variables. According to our observation in wafer fabrication, the following factors heavily influence the future performance of each operation stage.
(1) WIP levels of the current and previous two or three operation stages.
(2) Move volume of current and previous two or three operation stages.
(3) Disruptive factors such as machine breakdown, preventive maintenance, operator absence, and poor dispatching priorities.

The results presented here demonstrate that the first two factors, WIP levels and move volume, are significantly explanatory variables for the third one. Therefore, we select the first two factors as our input variables.

The fact that the performances of previous days and the future performances of an operation stage correlate with each other necessitates that two further concepts, operation stage window and operation time window must be defined to construct a BPN prediction model.

Operation stage window: the total number of operation stages involved in constructing the BPN prediction model, which include the current operation stage and previous operation stages. For instance, if the information retrieved for the BPN model includes only the current operation stage and the previous two operation stages, then the operation stage window = 3.

Operation time window: the size of time lagged to capture historical information from previous days. For instance, the information is captured from the current day and the previous two days to predict the performance of the current day. Then the operation time window = 3.

Figure 3 displays a BPN prediction model which is generated to predict the performance of stage $S$ on date $t+1$ ($\text{MOVE}_{s,t+1}$ and $\text{WIP}_{s,t+1}$), where $t$ denotes the observed day, and the input factors’ operation stage window = 2 and operation time window = 2.

Based on the data obtained so far, a correlation analysis has been performed to help determine the input variables. Table 1 depicts the correlation coefficients of the predicted performance and historical information from different input combinations.
The correlation coefficients shown in bold type are extremely high, indicating that the input variables are acceptable. The p-values of this correlation analysis ($H_0: \rho = 0$, $H_1: \rho \neq 0$) are also examined, as listed in table 2. The p-values indicate that the predicted variables are not independent of the input variables (p-value $\leq 0.0001$). The three-day historical WIP levels and move volumes in operation stage $s-1$ do not correlate well with the predicted move volumes (p-value $> 0.05$), but they still correlate with the WIP level on date $t+1$; therefore, those input variables cannot be excluded. The same scenario arises for the three-day historical WIP levels, and move volumes in operation stage $s-2$ do not correlate well with the WIP levels on date $t+1$.

3.2. Determination of the operation time window and operation stage window

The correlation analysis in section 3.1 allows us to confirm the appropriateness of the input variables chosen by previous experience. However, not all the input variables are expected to input to our model. In this study, the experimental design approach is employed to derive a better combination of operation stage window and operation time window so that the prediction error and model complexity can be reduced. By adopting previous experience, a $3 \times 3$ factorial design is generated. The operation stage window and operation time window are determined as the experimental factors (or treatments). Each factor is classified into three levels (table 3). Cumulatively, nine different BPN models are created.

The data set used to perform the experiment, consisting of 180 records for six months of daily data, was collected from the Mosel Vitelic Inc., which is a famous DRAM wafer fabricator in Taiwan. These data include the normal and abnormal occurrences. All the examined stages are located in the following manufacturing modules: photo, etching, thin film and diffusion. We delete 50 records whose data are not complete. To provide a mean for checking the BPN prediction against existing data, the remaining 130 records of available data are sub-divided into two sets. The first set, called training data, is used to construct the prediction model. 106 records of training data are available. To prevent over-training, the second set, called testing data (24 records), is used to assess the prediction model’s performance during the training process. This training process is repeated until the testing error, error between the actual and desired output from the testing data, converges to a predefined threshold value. The mean error percentage (MEP) and coefficient of variance (CV) are calculated to assess the performance of created BPN prediction models.
Three-day historical WIP levels of stage $s$, $s-1$ and $s-2$

<table>
<thead>
<tr>
<th>Predicted performance of stage $s$ on date $t+1$</th>
<th>Stage $s$</th>
<th>Stage $s-1$</th>
<th>Stage $s-2$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$(s_t)$</td>
<td>$(s_t-1)$</td>
<td>$(s_t-2)$</td>
<td>$(s_{t-1})$</td>
</tr>
<tr>
<td><strong>WIP$_{s,t+1}$</strong></td>
<td>0.936 14</td>
<td>0.839 16</td>
<td>0.772 56</td>
</tr>
<tr>
<td><strong>Move$_{s,t+1}$</strong></td>
<td>0.655 63</td>
<td>0.626 51</td>
<td>0.612 1</td>
</tr>
</tbody>
</table>

Three-day historical Move volumes of stage $s$, $s-1$ and $s-2$

<table>
<thead>
<tr>
<th>Predicted performance of stage $s$ on date $t+1$</th>
<th>Stage $s$</th>
<th>Stage $s-1$</th>
<th>Stage $s-2$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$(s_t)$</td>
<td>$(s_t-1)$</td>
<td>$(s_t-2)$</td>
<td>$(s_{t-1})$</td>
</tr>
<tr>
<td><strong>WIP$_{s,t+1}$</strong></td>
<td>0.936 14</td>
<td>0.839 16</td>
<td>0.772 56</td>
</tr>
<tr>
<td><strong>Move$_{s,t+1}$</strong></td>
<td>0.655 63</td>
<td>0.626 51</td>
<td>0.612 1</td>
</tr>
</tbody>
</table>

Table 1. The correlation coefficients between the input variables and predicted variables.

Three-day historical WIP levels of stage $s$, $s-1$ and $s-2$

<table>
<thead>
<tr>
<th>Predicted performance of stage $s$ on date $t+1$</th>
<th>Stage $s$</th>
<th>Stage $s-1$</th>
<th>Stage $s-2$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$(s_t)$</td>
<td>$(s_t-1)$</td>
<td>$(s_t-2)$</td>
<td>$(s_{t-1})$</td>
</tr>
<tr>
<td><strong>WIP$_{s,t+1}$</strong></td>
<td>0.0001</td>
<td>0.0001</td>
<td>0.0001</td>
</tr>
<tr>
<td><strong>Move$_{s,t+1}$</strong></td>
<td>0.0001</td>
<td>0.0001</td>
<td>0.0001</td>
</tr>
</tbody>
</table>

Three-day historical WIP levels of stage $s$, $s-1$ and $s-2$

<table>
<thead>
<tr>
<th>Predicted performance of stage $s$ on date $t+1$</th>
<th>Stage $s$</th>
<th>Stage $s-1$</th>
<th>Stage $s-2$</th>
</tr>
</thead>
<tbody>
<tr>
<td>$(s_t)$</td>
<td>$(s_t-1)$</td>
<td>$(s_t-2)$</td>
<td>$(s_{t-1})$</td>
</tr>
<tr>
<td><strong>WIP$_{s,t+1}$</strong></td>
<td>0.0001</td>
<td>0.0001</td>
<td>0.0001</td>
</tr>
<tr>
<td><strong>Move$_{s,t+1}$</strong></td>
<td>0.0001</td>
<td>0.0001</td>
<td>0.0001</td>
</tr>
</tbody>
</table>

Table 2. The $p$-values for correlation analysis.
mean error percentage (MEP) = \frac{\sum |Y - \hat{Y}|}{n} \times \% ,

coefficient of variance (CV) = \sqrt{\text{MSE}}/\bar{X} , \quad \text{MSE} = \frac{\sum (Y - \bar{Y})^2}{n-1} ,

where

\( Y \) is the historical value,
\( \hat{Y} \) is the predicted value, and
\( n \) is the sample size.

Owing to the limitations of time and cost, only five different stages were examined in this experiment. Although the results cannot be used to represent the entire production line, the same analysis procedure can be applied to analyse any operation stages in the entire production line. Table 4 summarizes the testing error and the performance judgment measures for all the nine WIP level and move volume prediction models. Hence, the average values of MEP used to identify the optimum model are calculated (table 5), since the output layer includes the above two predicted variables.

The data are also examined by a two-way ANOVA analysis (table 6). Some of those results for a 5% significance level can be summarized as follows.

1. The interactions between the operation time window and operation stage window are insignificant but close to the significance level.
2. The factor effects of the operation time window are insignificant.
3. The factor effects of the operation stage window are significant.

Based on the above experiment, we can conclude the following.
The optimum size of operation stage window (2 or 3) can be derived from Duncan’s multiple range test (Montgomery 1984), as shown in figure 4.

Increasing the size of operation time window does not reduce the prediction error, but increases the complexity of the prediction model.

The optimum model exists when operation stage window = 3 and operation time window = 1.

3.3. Determination of BPN model’s structure

A BPN model has an input layer, an output layer, and several hidden layers. Increasing the number of hidden layers increases the complexity of a BPN model. However, a guarantee does not exist that the model’s performance will be improved with an increasing number of hidden layers. Based on previous experience, only one
or two hidden layers yield a better error convergence (Yei 1993). The number of nodes in a hidden layer is another factor influencing the training process of creating a BPN model. Basically, more nodes in a hidden layer result in a smaller prediction error but a longer training time. Yei (1993) also recommended the following principle to determine the number of hidden nodes for the hidden layer: \( HN = \frac{a + b}{2} \), where \( a \) denotes the number of input nodes and \( b \) denotes the number of output nodes.

Sensitivity analysis is also performed to obtain a more refined structure of our BPN model. The previous BPN model with operation time window = 1 and operation stage window = 3 are modified by different numbers of hidden layers and nodes. Table 8 lists all the level’s combinations. From the average predicted error for WIP and Move shown in table 8, the following results are observed.

1. The number of hidden nodes should be determined by Yei’s formula \( HN = \frac{a + b}{2} \).
2. One or two hidden layers can yield a better prediction performance and therefore do not waste the training time.

These predicted errors are examined by a two-way ANOVA analysis. Those results suggest that the differences among predicted errors are insignificant. Therefore, advanced analysis does not have to be applied. The optimum case in table 8 was chosen to be the structure of our BPN prediction model.

### 3.4. An optimum BPN model

Only five stages were examined in our experiment. However, these results can not be used to represent the actual circumstances of the entire wafer fabrication. According to the results of section 3.2 and 3.3, an optimum level’s combination

<table>
<thead>
<tr>
<th>Factors</th>
<th>Levels</th>
</tr>
</thead>
<tbody>
<tr>
<td>Operation stage window</td>
<td>3 stages (SW = 3)</td>
</tr>
<tr>
<td>Operation time window</td>
<td>1 day (TW = 1)</td>
</tr>
<tr>
<td>No. of hidden layers</td>
<td>1 or 2 layers (HL = 1 or 2)</td>
</tr>
<tr>
<td>No. of nodes on the hidden layer</td>
<td>(No. of input nodes + No. of output nodes)/2 (NH = ( \frac{a + b}{2} ))</td>
</tr>
</tbody>
</table>

Table 9. An optimum BPN structure.

<table>
<thead>
<tr>
<th>Number of hidden layers</th>
<th>MEP</th>
<th>1 layer</th>
<th>2 layers</th>
<th>3 layers</th>
</tr>
</thead>
<tbody>
<tr>
<td>Number of nodes on the hidden layer</td>
<td>( \frac{a + b}{4} )</td>
<td>22( ^\dagger )</td>
<td>23</td>
<td>23</td>
</tr>
<tr>
<td></td>
<td>( \frac{a + b}{2} )</td>
<td>21( ^\dagger )</td>
<td>21( ^\dagger )</td>
<td>23</td>
</tr>
<tr>
<td></td>
<td>( a + b )</td>
<td>22</td>
<td>22</td>
<td>22</td>
</tr>
</tbody>
</table>

\( ^\dagger \) A 5-stage average testing error for the WIP and Move.

Table 8. Average predicted errors for WIP and Move.
was obtained by considering the minimum average prediction error for WIP and move volume. Table 9 lists the optimum level’s combinations. Figures 5 and 6 plot the predicted values and the real values: one for the WIP and the other for the move volume. As those figures reveal, using the optimum BPN

**Figure 5.** Predicted values VS real values for WIP level.
The performance prediction model obtained herein has an average prediction error of only 21%.

Next, the prediction errors were more closely examined. That examination confirmed a relationship between prediction error and the average variance of stage WIP.
and move volume. In generally, an operation stage with a larger average variance has a large prediction error, as shown in Table 10. Figure 7 depicts their relationships, as represented by the scatter chart. From this chart, a field manager can realize that for the operation stage with a smaller average variance the predicted performance from the BPN prediction model is more reliable.

Moreover, a multiple regression model was compared with the neural network prediction model. The models can be expressed as

\[ Y_{\text{Move}, s, t+1} = \beta_0 + \sum \beta_{gij} X_{gij} + \varepsilon_{gij}, \]

\[ Y_{\text{WIP}, s, t+1} = \beta_0 + \sum \beta_{gij} X_{gij} + \varepsilon_{gij}, \]

where

- \( X_{gij} \) are the input variables,
- \( g \) is WIP or move,
- \( i = s, s - 1 \) or \( s - 2 \), and
- \( j = t, t - 1 \) or \( t - 2 \).

By using the stepwise regression process, a prediction error of 26% was obtained. However, the prediction performance is not as high as the BPN model. For the cases presented here, the BPN prediction model is more appropriate than the regression model under the criteria of minimum prediction error.

4. Managerial implications and implementation

The previous section explored how to select an optimum BPN prediction model to accurately predict wafer fabrication performance. Herein, we recommend using a two-stage (creating and running) implementation procedure to implement the BPN
prediction model. Figure 8 illustrates the detailed process of these two stages. In the creating stage, the BPN model is trained by the new data obtained from the wafer fabrication. For this study, six months of information can adequately generate a good BPN prediction model.

In the running stage, the prediction results obtained from the BPN model are compared with the standard performance measures (standard WIP level and target move volume). The difference in this comparison (expressed as ‘low’, ‘normal’, or ‘high’) allows managers to quickly respond to any undesirable circumstances (table 11). The corrective actions are based on the interpretations of various combinations of low, normal and high levels of the predicted outputs. Hence, the way in which these levels are defined becomes very important. Logically, the reliability of this classification into levels is bound to be highly dependent on the magnitude of the prediction error. Although an experienced manager can roughly determine the levels with his own experiences and adjust these levels accordingly, the quality aspect of the prediction control level should be further studied.

Defining a standard WIP level and a target move volume at any stage is quite complex. Although this issue is not discussed here, the manager’s experience and the historical data help us to obtain a rough standard: (1) standard WIP level, average WIP during the past one week; and (2) target move, month output divided by the number of work days. For instance, if the month output is 36000 wafers and there are 30 work days in a month, a rough target move for one stage may be 1200 wafers per stage daily. (36000 wafers/30 work days = 1200 wafers/stage/day).

Model retraining becomes necessary when a system is changed (e.g. new routing is added). Otherwise, the current BPN model loses its ability to accurately predict the new system’s performance. The following criteria can be applied to determine the schedule for the model retraining: (1) new routing is added, or (2) cumulated prediction errors are outside the control limits after some time periods, e.g. two or three months.
<table>
<thead>
<tr>
<th>WIP level</th>
<th>Move volume</th>
<th>Possible reasons</th>
<th>Corrective actions</th>
</tr>
</thead>
<tbody>
<tr>
<td>High</td>
<td>Low</td>
<td>Machine down or preventive maintenance (PM)</td>
<td>Reschedule PM to keep normal moves</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Machine for engineering use (Machine lent)</td>
<td>Allocate machine properly to obtain more moves</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Machine allocated for the other stage</td>
<td>Solve the machine or operation problems of downstream stage</td>
</tr>
<tr>
<td></td>
<td></td>
<td>High WIP in downstream stage</td>
<td></td>
</tr>
<tr>
<td>High</td>
<td>Normal</td>
<td>High moves in upstream stage</td>
<td>Balance the moves in upstream stage</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Reallocate machine to obtain more moves and to reduce WIP</td>
</tr>
<tr>
<td>Low</td>
<td>Low</td>
<td>Low moves in upstream stage</td>
<td>Change the lot priority of upstream stage to obtain more moves for stage $s$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Machine starvation due to low WIP</td>
<td>Solve the machine or operation problems of stage $s$ or upstream stage</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Machine down or PM in stage $s$ or in upstream stage</td>
<td>Evaluate the impacts on downstream stage to avoid downstream machine starvation</td>
</tr>
<tr>
<td>Low</td>
<td>Normal</td>
<td>Low moves in upstream stage</td>
<td>Solve the machine or operation problems of the upstream stage</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Non-bottleneck stage</td>
<td>Change the lot priority of upstream stage to obtain more moves for stage $s$</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Obtain higher WIP to avoid starvation</td>
</tr>
<tr>
<td>Normal</td>
<td>Low</td>
<td>Machine allocated improperly</td>
<td>Evaluate the impacts on downstream stage to avoid downstream machine starvation</td>
</tr>
</tbody>
</table>

Table 11. Possible reasons and corrective actions for low performance in stage $S$. 
Training is the most time-consuming process in creating a BPN model. However, a well-trained BPN model can satisfy the requirement of real time running. Many commercial neural network programs with a powerful learning ability and good user interfaces have been developed. Such tools can be easily adapted by managers. In addition, to conserve the model construction time, the BPN model can only be applied to the key stages (including the bottleneck stages).

5. Conclusion and future works

This work constructs a performance prediction model that is capable of providing an advanced warning for the performance change of each operation stage in a DRAM wafer fabrication. The study of the BPN prediction model applied to a local wafer fabrication offers promising results when using a three-layer back-propagation neural network, thereby allowing for a more accurate prediction of the WIP level and move volume in the next time period for each wafer fabrication operation stage. Experimental results demonstrate that the optimum model is available when the input nodes include all the previous day’s information (WIP level and move volume) for three continuous previous stages. Also, the prediction results confirm that our model can provide a roughly 80% forecasting accuracy based on the existing data. Based on the BPN model construction procedure presented in this study, the Mosel Vitelic Inc. is now planning to construct and implement the performance prediction system.

Although the preliminary results are encouraging, additional study is necessary to improve the forecasting accuracy. In this study, the WIP level and move volume are the only two input variables. However, our models do not exhibit other factors that influence the production performance, such as machine breakdown and dispatching rules. If more data can be obtained and new factors that influence production performance can be included, more promising and meaningful models can be developed.

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